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T. Steptoe  
10-4-02



PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q62175

Yong-jun KIM, et al.

Appln. No.: 09/751,844

Group Art Unit: 2827

Confirmation No.: 9284

Examiner: Jeremy Norris

Filed: January 02, 2001

For: CIRCUIT BOARD AND METHOD FOR MANUFACTURING THEREOF

AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner for Patents  
Washington, D.C. 20231

Sir:

In response to the Office Action dated July 1, 2002, please amend the above-identified application as follows:

IN THE CLAIMS:

Please cancel claims 1, 4, 5, 10 and 11 without prejudice or disclaimer.

Please enter the following amended claims:

2. (Amended) A circuit board comprising: a dielectric substrate, a grounding

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surface formed on at least one surface of the dielectric substrate, and transmission lines formed on one surface of the dielectric substrate for transmitting electrical signals, wherein at least a portion of each of the transmission lines is isolated from an upper surface of the dielectric substrate to reduce an effective permittivity between the transmission lines and the grounding surface and reduce dielectric loss; and further comprising a plurality of dielectric supporters for

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